



# **Product Change Notification**

## **113334 - 00**

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# Product Change Notification

**Change Notification #:** 113334 - 00  
**Change Title:** **Boxed Intel® NUC Kit NUC5i5RYH, Single Pack, Boxed Intel® NUC Kit NUC5i5RYK, Single Pack**  
**PCN 113334-00**  
**Product Design**  
**Update Bios and add two power sense capacitors**  
**Date of Publication:** April 10, 2015

**Key Characteristics of the Change:**  
Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Apr 27, 2015
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## Description of Change to the Customer:

Intel is implementing the following changes.

1. The BIOS will be updated from RY0137 to RY0246. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
2. Adding capacitors to the power sensing circuit

## Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate the new BIOS to ensure a smooth transition. Intel validation of a new board revision does not include testing with older versions of BIOS. This change is not expected to cause a change to the Microsoft Windows\* operating system's software driver stack. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>

These changes have been evaluated to ensure there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

**Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>Pre Change AA</b>	<b>Pre Change SA</b>	<b>Post Change AA</b>	<b>Post Change SA</b>
BOXNUC5I5RYK	936793	H40999-502	H41218-102	H40999-503	H41218-103
BOXNUC5I5RYH	936891	H40999-502	H41219-102	H40999-503	H41219-103

**PCN Revision History:**

**Date of Revision:**

April 10, 2015

**Revision Number:**

00

**Reason:**

Originally Published PCN